

Features

- $I_{USB} = 35A$ typical
- $BV_{CES} > 80V$
- $BV_{CEO} > 15V$
- Specifically Designed for Low Voltage Avalanche Mode Operation
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **The DIODES™ FMMT411Q is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF16949 certified facilities.**

<https://www.diodes.com/quality/product-definitions/>

Mechanical Data

- Package: SOT23
- Package Material: Molded Plastic. "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish - Matte Tin-Plated Leads. Solderable per MIL-STD-202, Method 208 Ⓜ3
- Weight: 0.008 grams (Approximate)

Description

The FMMT411Q is a silicon planar bipolar transistor designed for operating in avalanche mode. Tight process control and low inductance packaging combine to produce high-current pulses with fast edges.

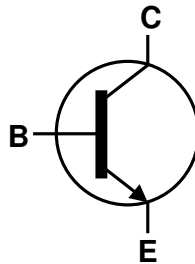
Applications

- Laser diode drivers for ranging and measurement (LIDAR)
- Fast edge switch generators
- High-speed pulse generators

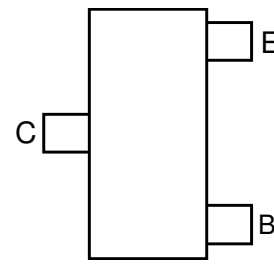
SOT23 (Type DN)



Top View



Device Symbol



Top View
Pin-Out

Ordering Information (Note 4)

Part Number	Package	Marking	Reel Size (inches)	Tape Width (mm)	Packing	
					Qty.	Carrier
FMMT411QTD	SOT23 (Type DN)	411	7	8	500	Reel
FMMT411QTA	SOT23 (Type DN)	411	7	8	3000	Reel

- Notes:
1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
 2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

Marking Information



411 = Product Type Marking Code
 YM = Date Code Marking
 Y or \bar{Y} = Year (ex: J = 2022)
 M or \bar{M} = Month (ex: 9 = September)

Date Code Key

Year	2022	2023	2024	2025	2026	2027	2028	2029	2030	2031	2032	2033
Code	J	K	L	M	N	O	P	R	S	T	U	V
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

Absolute Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V _{CBO}	80	V
Collector-Emitter Voltage	V _{CES}	80	V
Collector-Emitter Voltage	V _{CEO}	15	V
Emitter-Base Voltage	V _{EBO}	7	V
Continuous Collector Current	I _C	900	mA

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

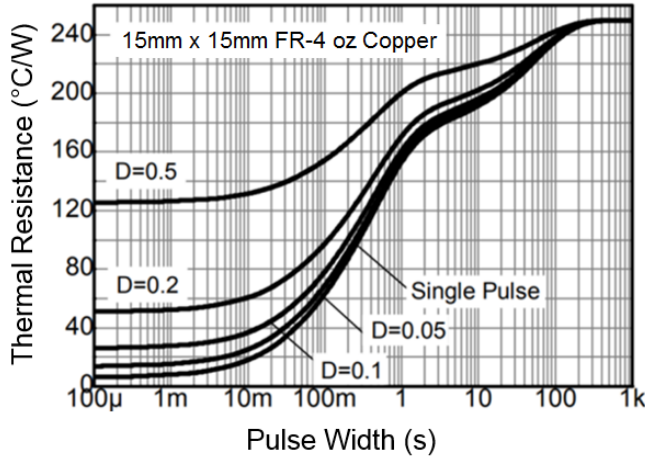
Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	P _D	800	mW
Thermal Resistance, Junction to Ambient (Note 5)	R _{θJA}	150	°C/W
Thermal Resistance, Junction to Case (Note 6)	R _{θJC}	30	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

ESD Ratings (Note 7)

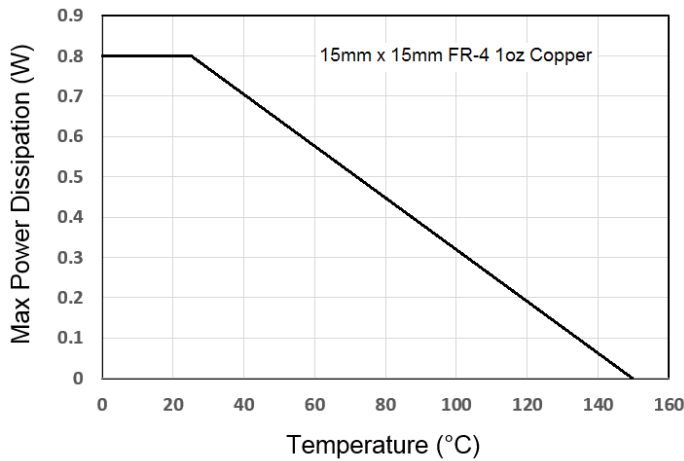
Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	4,000	V	3A
Electrostatic Discharge - Machine Model	ESD MM	400	V	C

- Notes:
5. For a device mounted with the collector lead on 15mm × 15mm 1oz copper that is on a single-sided 1.6mm FR-4 PCB; device is measured under still air conditions whilst operating in a steady state.
 6. Thermal resistance from junction to top of case.
 7. Refer to JEDEC specification JESD22-A114 and JESD22-A115.

Thermal Characteristics and Derating information



Transient Thermal Impedance



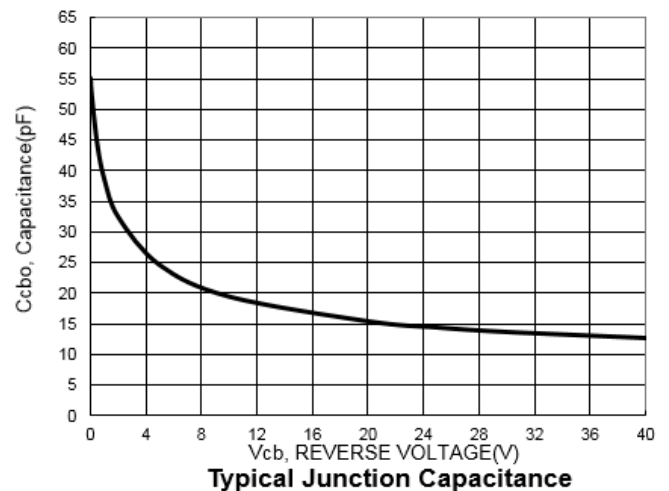
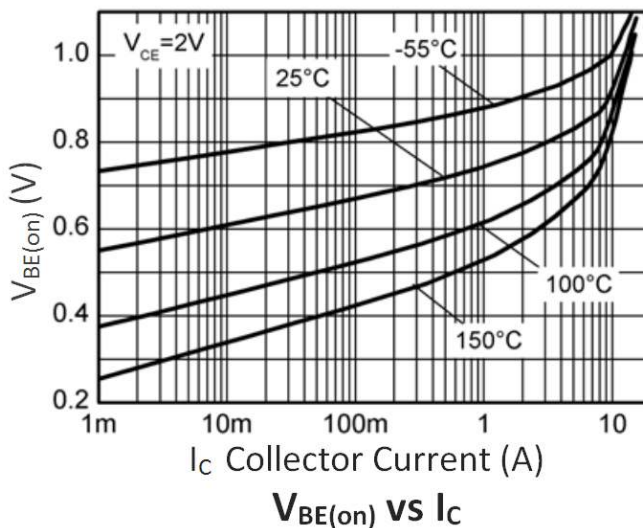
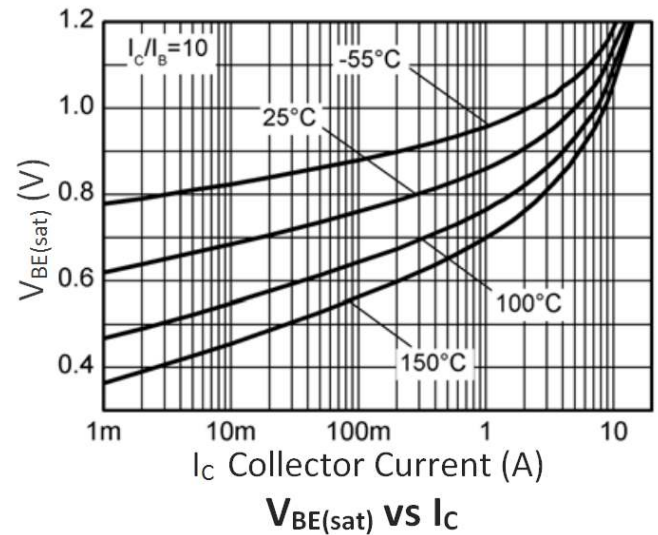
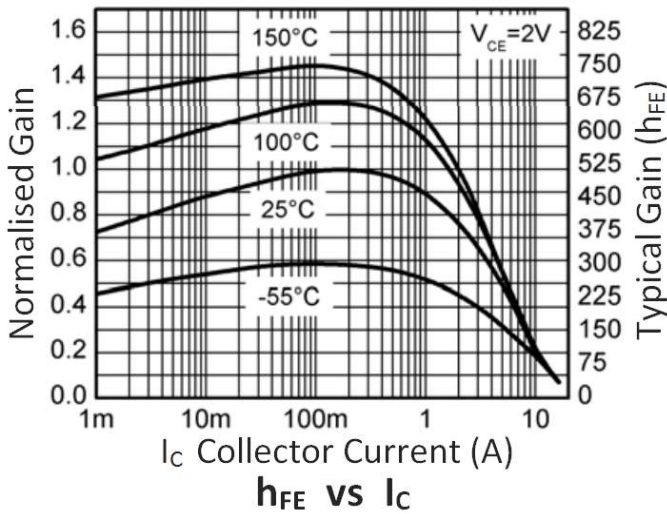
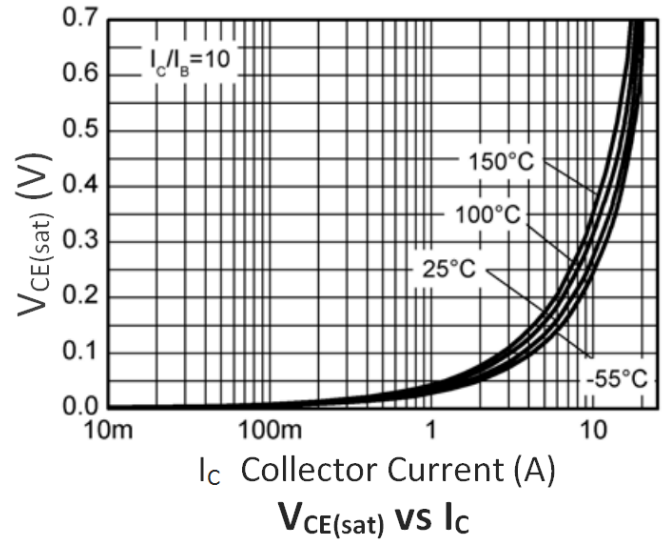
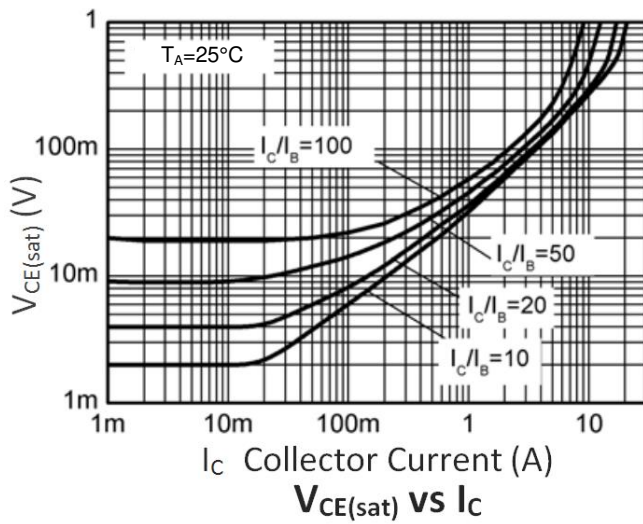
Derating Curve

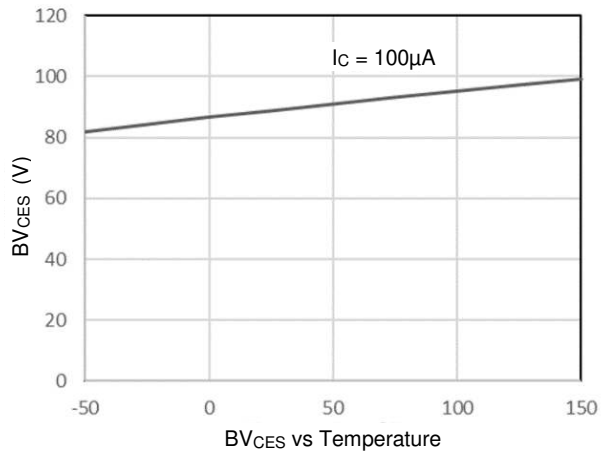
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV _{CBO}	80	—	—	V	I _C = 100μA
Collector-Emitter Breakdown Voltage	BV _{CES}	80 75	—	—	V	I _C = 100μA T _J = -50°C to +150°C
Collector-Emitter Breakdown Voltage	BV _{CEO}	15	—	—	V	I _C = 100μA
Emitter-Base Breakdown Voltage	BV _{EBO}	7	—	—	V	I _E = 100μA
Collector Cutoff Current	I _{CBO}	—	—	100 10	nA μA	V _{CB} = 75V V _{CB} = 75V, T _J = +100°C
Emitter Cutoff Current	I _{EBO}	—	—	20	nA	V _{EB} = 6V
Static Forward Current Transfer Ratio (Note 8)	h _{FE}	100	—	—	—	I _C = 10mA, V _{CE} = 10V
Collector-Emitter Saturation Voltage (Note 8)	V _{CE(sat)}	—	—	100	mV	I _C = 10mA, I _B = 1mA
Base-Emitter Saturation Voltage (Note 8)	V _{BE(sat)}	—	—	800	mV	I _C = 10mA, I _B = 1mA
Current in Second Breakdown (Pulsed) (Note 9)	I _{USB}	—	35	—	A	V _{CE} = 70V, C _{CE} = 470pF
Collector-Emitter Inductance	L _{ce}	—	2	—	nH	Standard SOT23 leads
Output Capacitance	C _{cbo}	—	15	—	pF	V _{CB} = 20V, f = 100MHz
Transition Frequency	f _T	40	—	—	MHz	V _{CE} = 20V, I _C = 10mA, f = 20MHz
Switching Times	t _d	—	118	—	ns	I _C = 100mA, V _{CC} = 10V I _{B1} = -I _{B2} = 10mA
	t _r	—	79	—	ns	
	t _s	—	388	—	ns	
	t _f	—	48	—	ns	

Notes: 8. Measured under pulsed conditions. Pulse width ≤ 300μs. Duty cycle ≤ 2%.
9. Dependent on circuit layout parasitics and base drive di/dt. Not production tested.

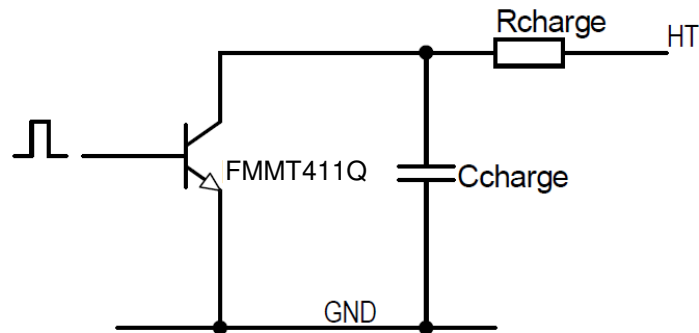
Typical Characteristics (@T_A = +25°C, unless otherwise specified.)





Application Considerations

In a typical circuit a large pulse is applied to the base and the resultant energy is enough to cause the onset of avalanche multiplication. Once breakdown has been established it will continue until the energy in the breakdown region is insufficient to maintain the condition, or the crystal lattice is permanently damaged. It is important therefore to limit the total energy expended during breakdown. The typical method of achieving avalanche uses the circuit shown below, wherein the energy per cycle is set by the charge voltage and capacitance value.



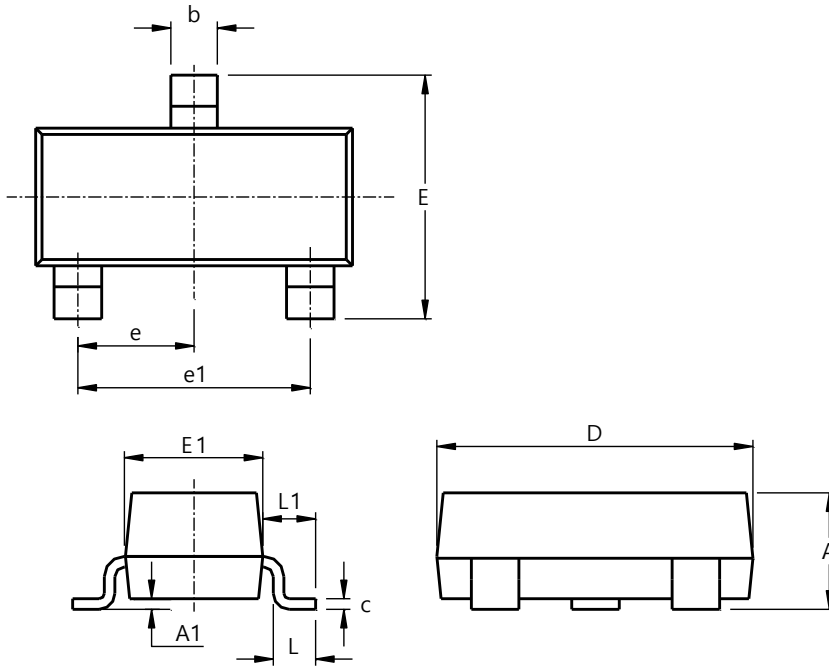
The effect of parasitic inductance in the circuit must be considered. Excessive inductance will reduce the current pulse height and slew current pulse edges. Loop area enclosed by the power circuit and track lengths should be minimized.

Thermal limitations must also be observed to ensure the transistor junction temperature is not exceeded. Avalanche power dissipation can be calculated from the energy per pulse and the pulse frequency, but PCB thermal resistance depends on many factors such as design, layout, and proximity of other components; so thermal performance should be verified by measurement.

Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOT23 (Type DN)

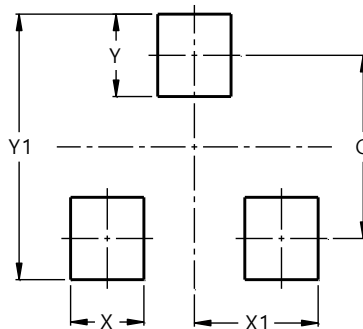


SOT23 Type DN			
Dim	Min	Max	Typ
A	0.89	1.12	1.00
A1	0.01	0.10	0.05
b	0.30	0.51	0.45
c	0.08	0.20	0.10
D	2.80	3.04	3.00
E	2.10	2.64	2.42
E1	1.20	1.40	1.37
e	0.95 REF		
e1	1.90 REF		
L	0.25	0.60	0.30
L1	0.45	0.62	0.54
All Dimensions in mm			

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOT23 (Type DN)



Dimensions	Value (in mm)
C	2.0
X	0.8
X1	1.35
Y	0.9
Y1	2.9

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